

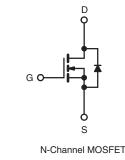
Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	500					
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.60				
Q _g (Max.) (nC)	84					
Q _{gs} (nC)	8.4					
Q _{gd} (nC)	50					
Configuration	Single					





FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third Generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247AC package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

ORDERING INFORMATION			
Package	TO-247AC		
Lead (Pb)-free	IRFP448PbF		
	SiHFP448-E3		
SnPb	IRFP448		
	SiHFP448		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	500	V		
Gate-Source Voltage			V _{GS}	± 20	V		
Continuous Drain Current	V_{GS} at 10 V $T_C = 25 \degree C$		-	11			
	VGS at 10 V	T _C = 100 °C	ID	6.6	A		
Pulsed Drain Current ^a			I _{DM}	44	1		
Linear Derating Factor				1.4			
Single Pulse Avalanche Energy ^b			E _{AS}	550	mJ		
Repetitive Avalanche Current ^a			I _{AR}	11	А		
Repetitive Avalanche Energy ^a			E _{AR}	18	mJ		
Maximum Power Dissipation	T _C =	25 °C	PD	180	W		
Peak Diode Recovery dV/dt ^c	•		dV/dt	3.5	V/ns		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150			
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d	- °C		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in		
			F	1.1	N · m		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 8.2 mH, $R_g = 25 \Omega$, $I_{AS} = 11 \text{ A}$ (see fig. 12). c. $I_{SD} \le 11 \text{ A}$, dl/dt $\le 120 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R _{thJA}	- 40			°C/W				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24 - - 0.70							
Maximum Junction-to-Case (Drain)	R _{thJC}					1			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherw	vise noted)							
PARAMETER	SYMBOL	TEST	CONDITION	NS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 250	μA	500	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, I _D	= 1 mA	-	0.60	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$			2.0	-	4.0	V	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 \text{ V}$			-	-	± 100	nA	
Zava Cata Valtaga Duain Cuurant	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	0 V	-	-	25	μA			
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 400 \text{ V}, \text{V}_{GS} = 0 \text{ V}, \text{T}_{\text{J}} = 125 ^{\circ}\text{C}$		-	-		250		
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D =	6.6 A ^b	-	-	0.60	Ω	
Forward Transconductance	9 _{fs}	V _{DS} = 50	0 V, I _D = 6.6	6 A ^b	6.7	-	-	S	
Dynamic		•							
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	1900	-	pF		
Output Capacitance	C _{oss}			-	490	-			
Reverse Transfer Capacitance	C _{rss}			-	220	-			
Total Gate Charge	Qg				-	-	84		
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V} \qquad \begin{array}{c} I_{D} = 9.6 \text{ A}, V_{DS} = 400 \text{ V}, \\ \text{see fig. 6 and } 13^{b} \end{array}$			-	-	8.4	nC	
Gate-Drain Charge	Q _{gd}			-	-	50			
Turn-On Delay Time	t _{d(on)}		1		-	18	-		
Rise Time	t _r	$V_{DD} = 250 \text{ V}, \text{ I}_D = 9.6 \text{ A},$ $R_G = 7.8 \ \Omega, \ R_D = 27 \ \Omega, \ \text{see fig. 10}^{\text{b}}$		2 4	-	40	-		
Turn-Off Delay Time	t _{d(off)}			-	62	-	ns		
Fall Time	t _f			-	32	-			
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	5.0	-	• nH		
Internal Source Inductance	L _S			-	13	-			
Drain-Source Body Diode Characteristic	s								
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	11	A		
Pulsed Diode Forward Current ^a	I _{SM}	p - n junction diode			-	-		44	
Body Diode Voltage	V_{SD}	$T_{J} = 25 \ ^{\circ}\text{C}, \ I_{S} = 11 \ \text{A}, \ V_{GS} = 0 \ V^{b}$			-	-	1.7	V	
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 9.6 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^b$		-	480	1100	ns		
Body Diode Reverse Recovery Charge	\circ			- 1	5.2	12	μC		
Body Blode Neverse Necovery Charge	Q _{rr}							F -	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

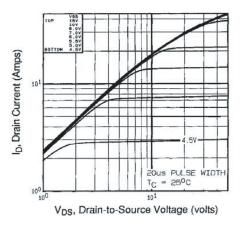


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^\circ C$

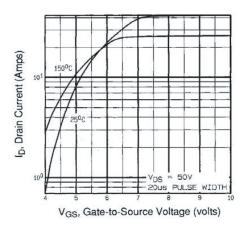


Fig. 3 - Typical Transfer Characteristics

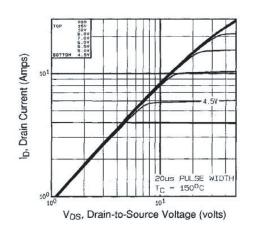


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^{\circ}C$

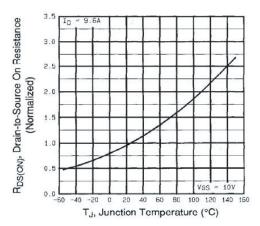


Fig. 4 - Normalized On-Resistance vs. Temperature

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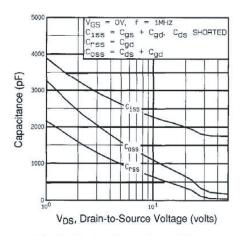


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

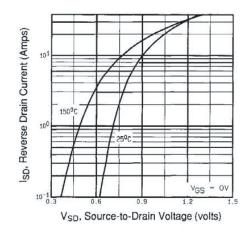


Fig. 7 - Typical Source-Drain Diode Forward Voltage

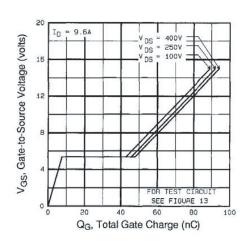


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

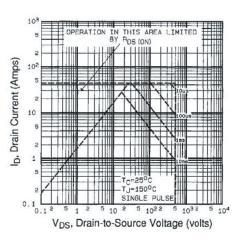


Fig. 8 - Maximum Safe Operating Area



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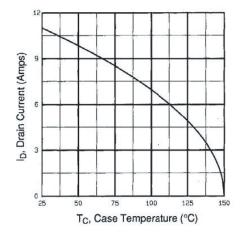


Fig. 9 - Maximum Drain Current vs. Case Temperature

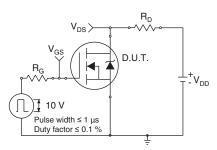


Fig. 10a - Switching Time Test Circuit

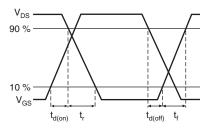


Fig. 10b - Switching Time Waveforms

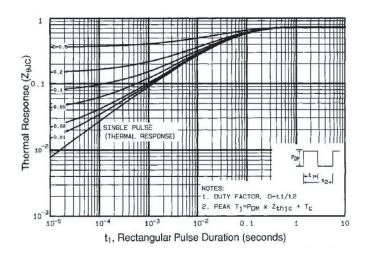


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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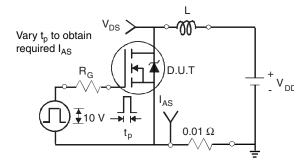


Fig. 12a - Unclamped Inductive Test Circuit

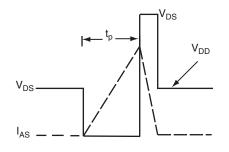


Fig. 12b - Unclamped Inductive Waveforms

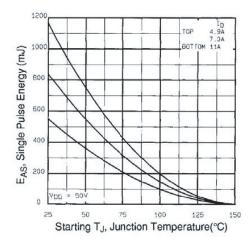
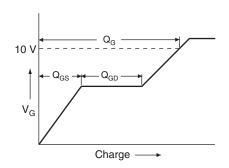


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





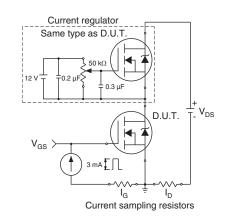
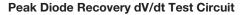


Fig. 13b - Gate Charge Test Circuit

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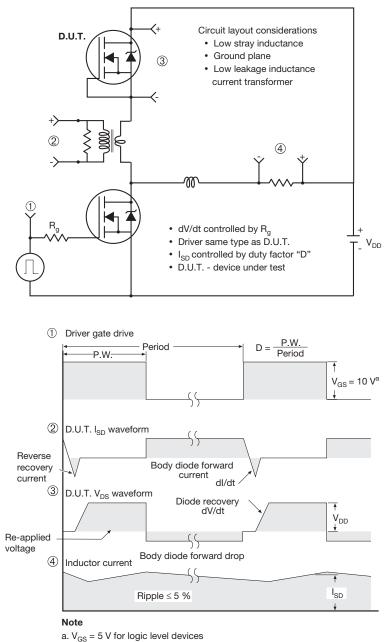


Fig.14 - For N-Channel

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TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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